

# LNJ414K8YRA

## Surface Mounting Chip LED

USS Type

■ Absolute Maximum Ratings  $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Power dissipation	$P_D$	40	mW
Forward current	$I_F$	15	mA
Pulse forward current *	$I_{FP}$	50	mA
Reverse voltage	$V_R$	3	V
Operating ambient temperature	$T_{opr}$	-30 to +85	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-40 to +100	$^\circ\text{C}$

■ Lighting Color

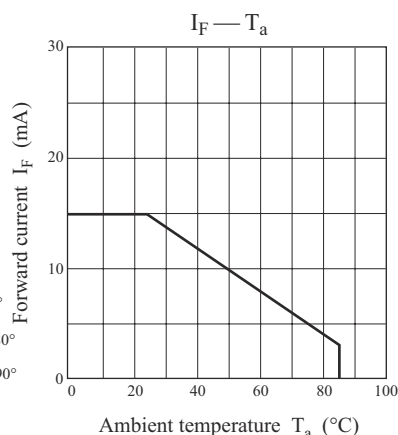
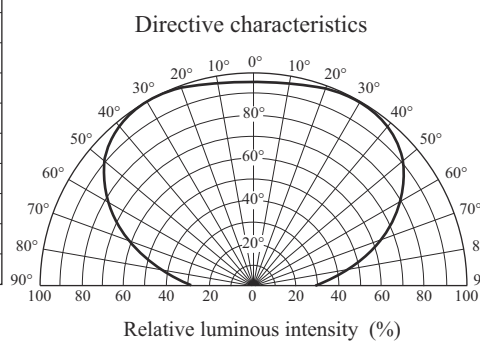
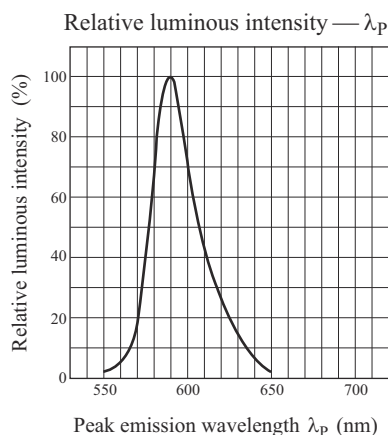
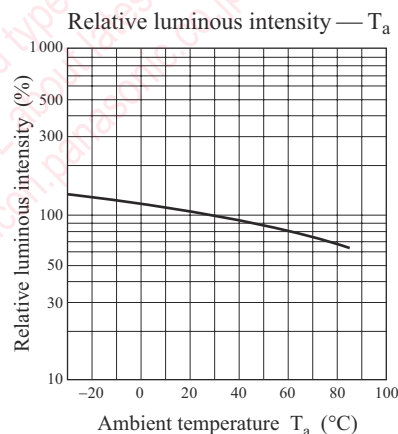
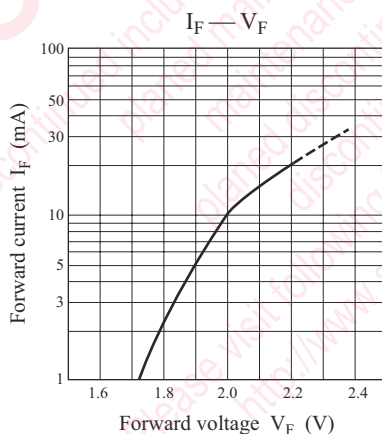
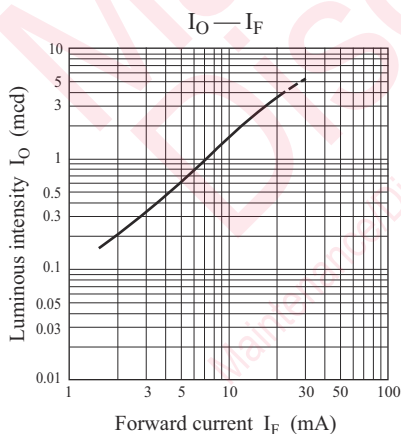
- Amber

Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

■ Electro-Optical Characteristics  $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

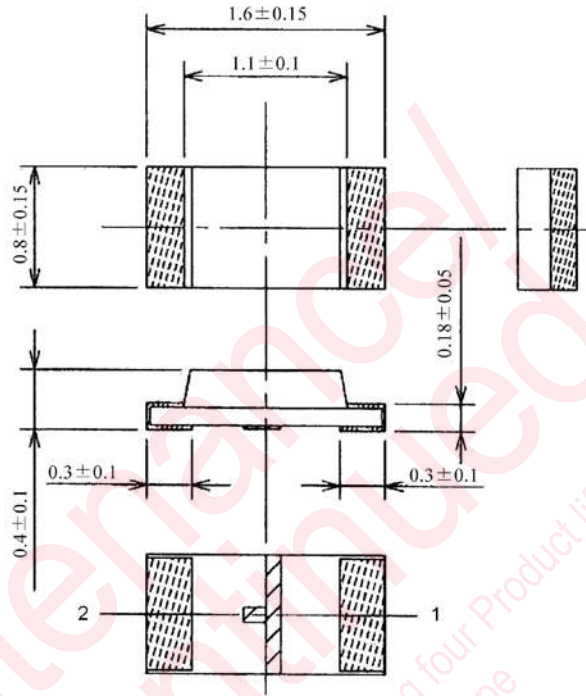
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity *	$I_O$	$I_F = 10 \text{ mA}$	0.75	1.5		mcd
Reverse current	$I_R$	$V_R = 3 \text{ V}$			10	$\mu\text{A}$
Forward voltage	$V_F$	$I_F = 10 \text{ mA}$		2.0	2.6	V
Peak emission wavelength	$\lambda_p$	$I_F = 10 \text{ mA}$		590		nm
Spectral half band width	$\Delta\lambda$	$I_F = 10 \text{ mA}$		30		nm

Note) \*: Measurement tolerance:  $\pm 20\%$



■ Package (Unit: mm)

KLTF2N2K1400



- Pin name
- 1: Anode
- 2: Cathode

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planned maintenance type  
maintenance type  
planned discontinued type  
discontinued type  
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